



## PATENT APPLICATION

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

pplicant:

Kumar et al.

Serial No.:

09/903,114

Filed:

July 11, 2001

For:

THERMAL PROCESSING

SYSTEM AND METHODS FOR FORMING LOW-K DIELECTRIC

FILMS SUITABLE FOR

INCORPORATION INTO MICRO-

**ELECTRONIC DEVICES** 

Group Art Unit: 1762

Docket No.:

FSI0006/US/2

Commissioner for Patents Washington, DC 20231

I CERTIFY THAT ON + 16 22 2002 BEING DEPOSITED WITH THE U.S. POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO THE COMMISSIONER FOR PATENTS, WASHINGTON, DC 20231

## REQUEST FOR EXTENSION OF TIME UNDER 37 CFR 1.136(a)

Commissioner for Patents Washington, DC 20231

Dear Sir

Applicants respectfully petition the Commissioner for Patents to extend the time for response to the Notice to File Missing Parts of Nonprovisional Application mailed August 24, 2001, for four months from October 24, 2001, to February 24, 2002.

Enclosed is a check that includes the \$1,440.00 fee. Please charge any additional fees to Deposit Account No. 50-1775.

Respectfully submitted,

teb 22, 2002

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